

# STP75NF75L STB75NF75L STB75NF75L-1

N-CHANNEL 75V - 0.009  $\Omega$  - 75A D<sup>2</sup>PAK/I<sup>2</sup>PAK/TO-220 STripFET™ II POWER MOSFET

TYPE	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STB75NF75L/-1	75 V	<0.011 Ω	75 A
STP75NF75L	75 V	<0.011 Ω	75 A

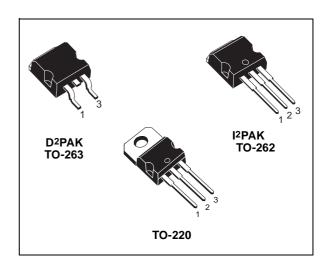
- TYPICAL  $R_{DS}(on) = 0.009\Omega$
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- LOW THRESHOLD DRIVE

#### **DESCRIPTION**

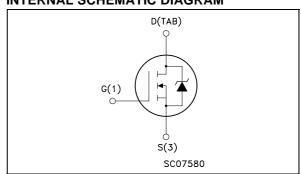
This MOSFET series realized with STMicroelectronics unique STripFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced highefficiency, high-frequency isolated DC-DC converters for Telecom and Computer applications. It is also intended for any applications with low gate drive requirements.

#### **APPLICATIONS**

- SOLENOID AND RELAY DRIVERS
- DC MOTOR CONTROL
- DC-DC CONVERTERS
- AUTOMOTIVE ENVIRONMENT



# INTERNAL SCHEMATIC DIAGRAM



#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source Voltage (V <sub>GS</sub> = 0)	75	V
V <sub>DGR</sub>	Drain-gate Voltage (R <sub>GS</sub> = 20 kΩ)	75	V
V <sub>GS</sub>	Gate- source Voltage	± 15	V
I <sub>D</sub> (•)	Drain Current (continuous) at T <sub>C</sub> = 25°C	75	А
I <sub>D</sub>	Drain Current (continuous) at T <sub>C</sub> = 100°C	70	А
I <sub>DM</sub> (••)	Drain Current (pulsed)	300	A
P <sub>tot</sub>	Total Dissipation at T <sub>C</sub> = 25°C	300	W
	Derating Factor	2	W/°C
dv/dt (1)	Peak Diode Recovery voltage slope	20	V/ns
E <sub>AS</sub> (2)	Single Pulse Avalanche Energy	680	mJ
T <sub>stg</sub>	Storage Temperature	-55 to 175	°C
Tj	Max. Operating Junction Temperature	-55 to 175	

<sup>(•)</sup> Current limited by package

(••) Pulse width limited by safe operating area.

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(1)  $I_{SD} \le 75A$ ,  $di/dt \le 500A/\mu s$ ,  $V_{DD} \le V_{(BR)DSS}$ ,  $T_j \le T_{JMAX}$ . (2) Starting  $T_j = 25$  °C,  $I_D = 37.5A$ ,  $V_{DD} = 30V$ 

# **STB75NF75L/-1 STP75NF75L**

## THERMAL DATA

# **ELECTRICAL CHARACTERISTICS** (T<sub>case</sub> = 25 °C unless otherwise specified)

# OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source Breakdown Voltage	$I_D = 250 \ \mu A$ $V_{GS} = 0$	75			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0)	$V_{DS} = Max Rating$ $V_{DS} = Max Rating T_C = 125^{\circ}C$			1 10	μA μA
I <sub>GSS</sub>	Gate-body Leakage Current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 15 V			±100	nA

# ON (\*)

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$	I <sub>D</sub> = 250 μA	1		2.5	V
R <sub>DS(on)</sub>	Static Drain-source On Resistance	V <sub>GS</sub> = 10 V V <sub>GS</sub> = 5 V	$I_D = 37.5 A$ $I_D = 37.5 A$		0.009 0.010	0.011 0.013	$\Omega$

# **DYNAMIC**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g <sub>fs</sub> (*)	Forward Transconductance	$V_{DS} = 15 \text{ V}$ $I_D = 37.5 \text{ A}$		120		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DS} = 25V$ , $f = 1 MHz$ , $V_{GS} = 0$		4300 660 205		pF pF pF

# **ELECTRICAL CHARACTERISTICS** (continued)

## **SWITCHING ON**

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on Delay Time Rise Time	$\begin{array}{ccc} V_{DD} = 40 \text{ V} & I_D = 37.5 \text{ A} \\ R_G = 4.7 \; \Omega & V_{GS} = 4.5 \text{ V} \\ \text{(Resistive Load, Figure 3)} \end{array}$		35 150		ns ns
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total Gate Charge Gate-Source Charge Gate-Drain Charge	V <sub>DD</sub> = 60V I <sub>D</sub> = 75 A V <sub>GS</sub> = 5V		75 18 31	90	nC nC nC

## **SWITCHING OFF**

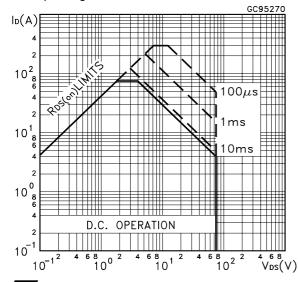
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t <sub>d(off)</sub>	Turn-off Delay Time Fall Time	$\label{eq:VDD} \begin{array}{lll} V_{DD} = 40 \text{ V} & I_D = 37.5 \text{ A} \\ R_G = 4.7\Omega, & V_{GS} = 4.5 \text{ V} \\ \text{(Resistive Load, Figure 3)} \end{array}$		110 60		ns ns

#### SOURCE DRAIN DIODE

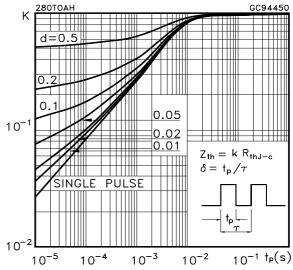
Symbol	Parameter	Parameter Test Conditions		Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain Current Source-drain Current (pulsed)				75 300	A A
V <sub>SD</sub> (*)	Forward On Voltage	I <sub>SD</sub> = 75 A V <sub>GS</sub> = 0			1.3	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse Recovery Time Reverse Recovery Charge Reverse Recovery Current	$I_{SD} = 75 \text{ A}$		100 380 7.5		ns nC A

<sup>(\*)</sup>Pulsed: Pulse duration = 300 µs, duty cycle 1.5 %.
(•)Pulse width limited by safe operating area.





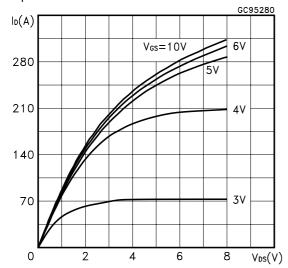
# Thermal Impedance



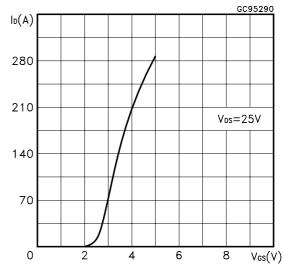
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# **STB75NF75L/-1 STP75NF75L**

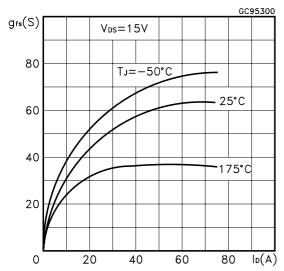
# **Output Characteristics**



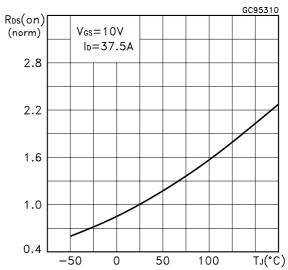
#### **Transfer Characteristics**



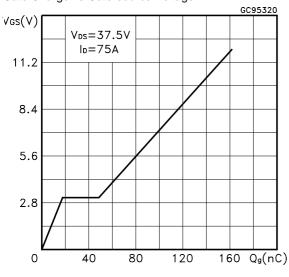
#### Transconductance



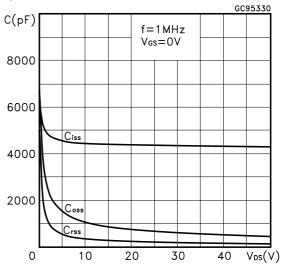
Static Drain-source On Resistance



# Gate Charge vs Gate-source Voltage

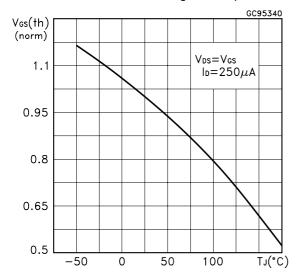


# Capacitance Variations

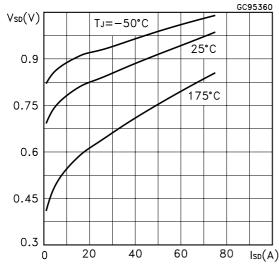


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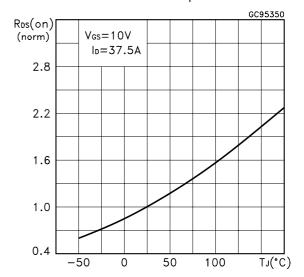
# Normalized Gate Threshold Voltage vs Temperature



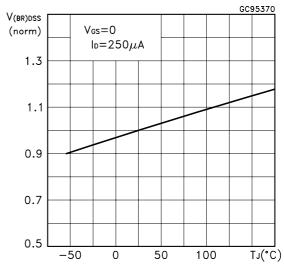
## Source-drain Diode Forward Characteristics



# Normalized on Resistance vs Temperature



## Normalized Breakdown Voltage vs Temperature.



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**△√√** 

Fig. 1: Unclamped Inductive Load Test Circuit

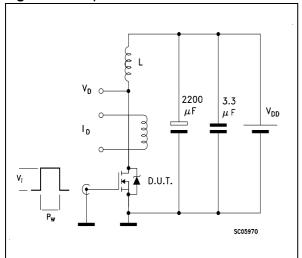
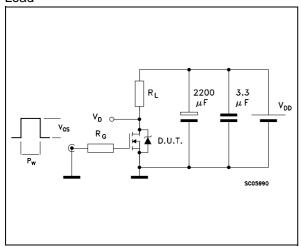


Fig. 3: Switching Times Test Circuits For Resistive Load



**Fig. 5:** Test Circuit For Inductive Load Switching And Diode Recovery Times

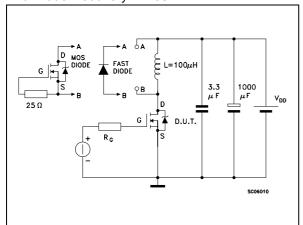


Fig. 2: Unclamped Inductive Waveform

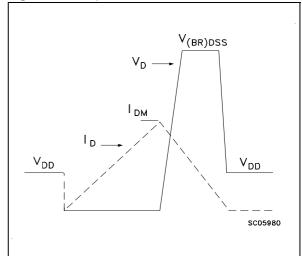
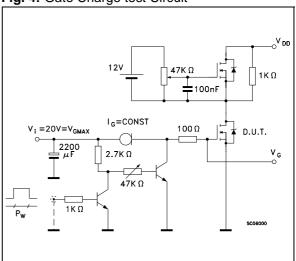
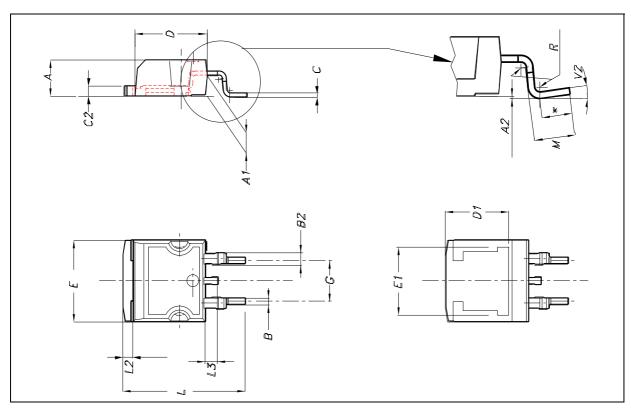


Fig. 4: Gate Charge test Circuit



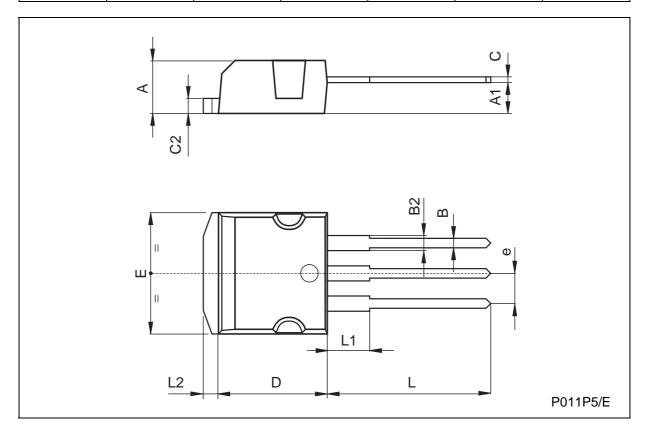
# D<sup>2</sup>PAK MECHANICAL DATA

DIM.		mm.			inch.			
DINI.	MIN.	TYP.	MAX.	MIN.	TYP.	TYP.		
Α	4.4		4.6	0.173		0.181		
<b>A</b> 1	2.49		2.69	0.098		0.106		
A2	0.03		0.23	0.001		0.009		
В	0.7		0.93	0.028		0.037		
B2	1.14		1.7	0.045		0.067		
С	0.45		0.6	0.018		0.024		
C2	1.21		1.36	0.048		0.054		
D	8.95		9.35	0.352		0.368		
D1		8			0.315			
E	10		10.4	0.394		0.409		
E1	8.5				0.334			
G	4.88		5.28	0.192		0.208		
L	15		15.85	0.591		0.624		
L2	1.27		1.4	0.050		0.055		
L3	1.4		1.75	0.055		0.069		
М	2.4		3.2	0.094		0.126		
R		0.4			0.016			
V2	0°		8°	0°		8°		



# TO-262 (I<sup>2</sup>PAK) MECHANICAL DATA

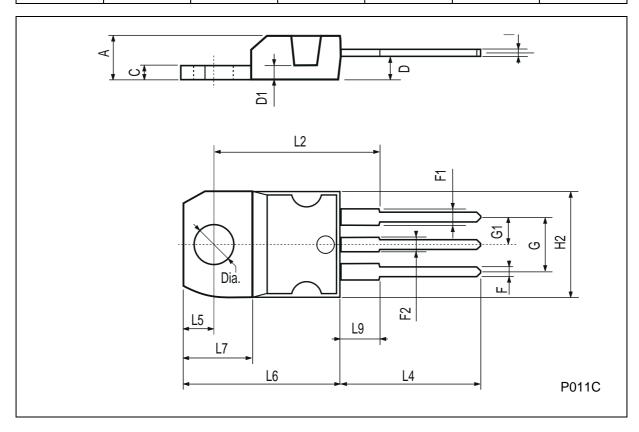
DIM.		mm			inch	
<b>D</b> 11111.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α	4.4		4.6	0.173		0.181
A1	2.49		2.69	0.098		0.106
В	0.7		0.93	0.027		0.036
B2	1.14		1.7	0.044		0.067
С	0.45		0.6	0.017		0.023
C2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
е	2.4		2.7	0.094		0.106
E	10		10.4	0.393		0.409
L	13.1		13.6	0.515		0.531
L1	3.48		3.78	0.137		0.149
L2	1.27		1.4	0.050		0.055



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# **TO-220 MECHANICAL DATA**

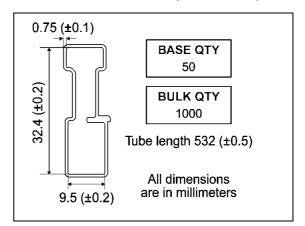
DIM.		mm				
DINI.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
Е	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



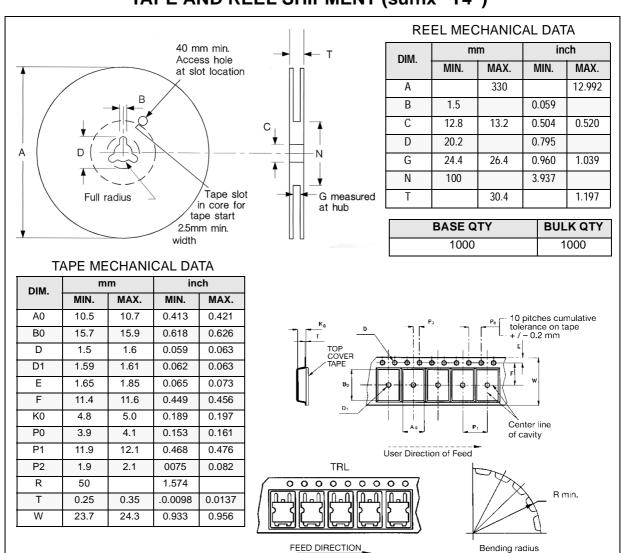
# **D2PAK FOOTPRINT**

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# **TUBE SHIPMENT (no suffix)\***



# TAPE AND REEL SHIPMENT (suffix "T4")\*



<sup>\*</sup> on sales type

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